IN THE CLAIMS:

Please note that all claims currently pending and under consideration in the referenced application are shown below, in clean form, for clarity. No amendments have been made herein.

- 1. (Twice Amended) A semiconductor device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising: at least one layer of boro-phospho silicate glass; and at least one layer of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of said at least one layer of boro-phospho silicate glass.
- 2. (Amended) A semiconductor device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising:
 a plurality of layers of boro-phospho silicate glass; and
 a plurality of layers of germanium boro-phospho silicate glass, at least a portion of at least one layer of said plurality of layers of germanium boro-phospho silicate glass contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.
- 3. (Twice Amended) A semiconductor device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising:
 a plurality of layers of boro-phospho silicate glass; and
 a plurality of layers of germanium boro-phospho silicate glass, each layer of said plurality of layers of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.

- 4. (Twice Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising: at least one layer of boro-phospho silicate glass; and at least one layer of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of said at least one layer of boro-phospho silicate glass.
- 5. (Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising:
 a plurality of layers of boro-phospho silicate glass; and
 a plurality of layers of germanium boro-phospho silicate glass, at least a portion of at least one layer of said plurality of layers of germanium boro-phospho silicate glass contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.
- 6. (Twice Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising:
 a plurality of layers of boro-phospho silicate glass; and
 a plurality of layers of germanium boro-phospho silicate glass, each layer of said plurality of layers of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.
- 7. (Twice Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising: at least one capacitor cell having a portion thereof formed by at least one layer of boro-phospho silicate glass and at least one layer of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of said at least one layer of boro-phospho silicate glass.

- 8. (Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising:
 at least one capacitor cell having a portion thereof formed by a plurality of layers of boro-phospho silicate glass and a plurality of layers of germanium boro-phospho silicate glass, at least a portion of at least one layer of said plurality of layers of germanium boro-phospho silicate glass contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.
- 9. (Amended) A semiconductor memory device having at least one memory cell having a capacitor cell formed of multiple layers of glass comprising: at least one capacitor cell having a portion thereof formed by a plurality of layers of boro-phospho silicate glass and a plurality of layers of germanium boro-phospho silicate glass, each layer of germanium boro-phospho silicate glass having at least a portion thereof contacting at least a portion of at least one layer of said plurality of layers of boro-phospho silicate glass.
- 10. (Previously Amended) The memory device of claim 9, further comprising: at least one dielectric layer; and a conductive layer over said at least one dielectric layer.
- 11. (Previously Amended) The memory device of claim 10, wherein said at least one dielectric layer comprises one of Si₃N₄, Ta₂O₅, or BST.
- 12. (Previously Amended) The memory device of claim 10, wherein said conductive layer comprises Si-Ge.

13. (Previously Amended) The memory device of claim 9, further comprising: at least one dielectric layer covering at least portions of said plurality of layers of boro-phospho silicate glass and said plurality of layers of germanium boro-phospho silicate glass; and a conductive layer covering at least a portion of said at least one dielectric layer.